

FIG. 1

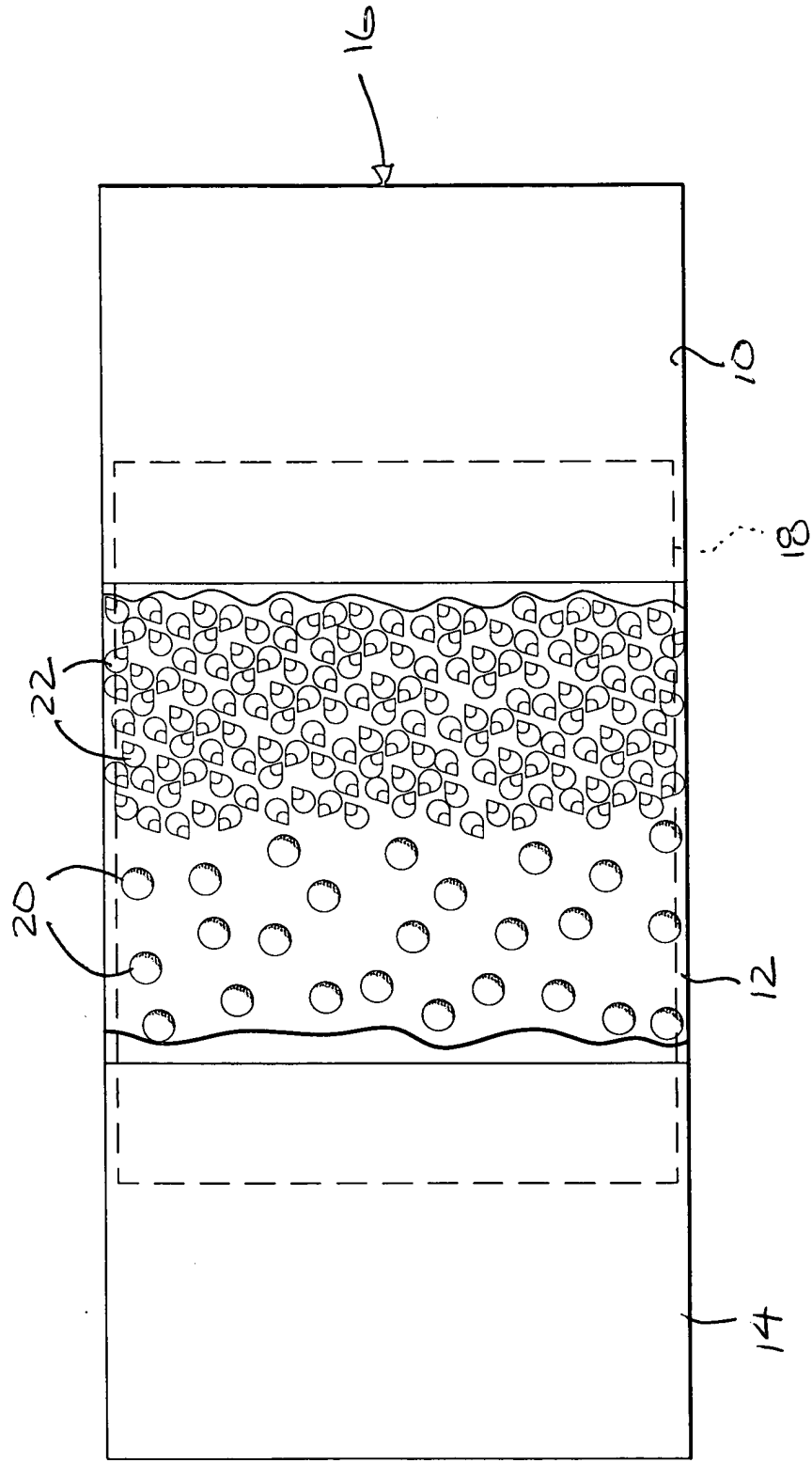


FIG. 2 is a cross-sectional view of a device 10, showing a substrate 12, a first layer 14, a second layer 16, and a third layer 18. The first layer 14 contains a pattern of circular features 20. The second layer 16 contains a pattern of circular features 22. The third layer 18 is a solid layer. The device 10 is shown in a cross-sectional view, with the layers 12, 14, 16, and 18 stacked vertically. The first layer 14 and the second layer 16 are separated by a dashed line, indicating a boundary or interface. The circular features 20 and 22 are distributed throughout the layers 14 and 16, respectively. The substrate 12 is the bottom layer, and the third layer 18 is the top layer. The device 10 is shown in a cross-sectional view, with the layers 12, 14, 16, and 18 stacked vertically.

FIG. 2

